



The 18th IEEE International Conference on Scalable Computing and Communications (ScalCom 2018)

October 8-12, 2018, Guangzhou, China

Call for WiP Papers

In addition to full-length regular papers, the IEEE ScalCom 2018 welcomes Work-in-Progress (WiP) papers showing innovative and original research in the areas of smart world. Submissions from both industry and academia are strongly encouraged.

WiP papers are expected to report on early or ongoing research activities. The WiP session will provide a forum to discuss novel ideas and emerging results, presenting innovative applications and tools, and bring about novel research questions, approaches, and directions.

Submission Guidelines

WiP papers may be no more than 6 pages in length, or at most 2 additional pages with the pages overlength charge, including figures, tables, and references.

WiP papers are expected to present early or ongoing research activities. Novel approaches and preliminary results are especially appreciated.

The submitted manuscripts will be reviewed by members of the ScalCom 2018 Technical Program Committee. All selected papers will be orally presented in a special conference session. At least one author of each accepted paper must register and attend the conference to present the work. The accepted papers will be published in the conference proceedings by IEEE, and will be included in the Digital Library in IEEE Xplore.

Authors are requested to submit original, unpublished manuscripts in standard IEEE proceedings format in PDF. All submissions must be typeset in double-column IEEE format using 10pt fonts on US letter paper, with all fonts embedded. Submitted papers must include the contact information of all the authors. Please make sure you use the latest version of the templates to prepare your submissions. Due to the short interval between the notification of acceptance and the camera-ready deadline, we strongly encourage authors to follow the camera-ready formatting guidelines as close as possible.

The IEEE LaTeX and Microsoft Word templates for conferences can be found at IEEE Manuscript Templates for Conference Proceedings at:

http://www.ieee.org/conferences_events/conferences/publishing/templates.html

Submissions must be made via EasyChair:

<https://easychair.org/conferences/?conf=smartworld2018>

When submitting, please select the appropriate Track for your paper (i.e., WiP).

Best Work-in-Progress Paper Award

IEEE ScalCom 2018 will be offering an award recognizing the Best Work-in-Progress Paper presented at the conference. During the Work-in-Progress session, your paper will be reviewed by a judging panel selected from the conference organizing and program committee. Your paper will be judged based on the novelty, quality of research undertaken and clarity of presentation. The Best Work-in-Progress Paper will receive an Award Certificate.